



# 2017 INTERNATIONAL MICROWAVE SYMPOSIUM

4 – 9 JUNE 2017 HONOLULU, HAWAII

## CALL FOR PAPERS

### 2017 INTERNATIONAL MICROWAVE SYMPOSIUM SPECIAL ISSUE OF THE IEEE TRANSACTIONS ON MICROWAVE THEORY AND TECHNIQUES

The **IEEE Transactions on Microwave Theory and Techniques (IEEE T-MTT)** will publish a Special Issue devoted to the **2017 International Microwave Symposium (IMS2017)**. Authors of all papers presented at IMS2017 are invited to submit an expanded version of IMS papers to the Special Issue. The expanded version requires new technical content which provides a more in-depth treatment, or demonstrates results beyond the IMS paper, and takes advantage of the discussions generated at the conference, leading to the possibility of different results or interpretations. Every paper will be reviewed by T-MTT in the same manner as all other regular submissions to this publication.

Please note:

- Papers should be submitted through the T-MTT Manuscript Central site: <http://mc.manuscriptcentral.com/tmtt-ieee>
- After logging in (or creating a new account) click on "Author" > "Start New Submission" > "Begin Submission"; then select "2017 IMS Special Issue" in the "Type" menu.
- The IMS2017 conference paper should be included with the submission as well (required).
- Discuss the expansion over the IMS2017 conference paper in the Introduction (required).
- The following note should be added to the footnote on the first page of the paper: "This paper is an expanded version from the 2017 International Microwave Conference, Honolulu, HI, 4–9 June 2017" (required).
- All submissions must follow the 'New Manuscript Checklist', which can be found by clicking the 'Information for Authors' link on the T-MTT website (<https://www.mtt.org/transactions>)
- T-MTT will not accept papers that describe a single passive antenna or a passive array of antennas. Electronic systems or circuits that include an antenna may be submitted.
- The submission deadline is **1 July 2017**.

If you have any questions, please contact us at the following address:

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Olga Boric-Lubecke and Ryan Miyamoto

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